




SPECIFICATION SHEET

SPECIFICATION SHEET NO.	N1004- SOD5235Z24S05S
DATE	Oct. 04, 2021
REVISION	A0
DESCRIPTION	<p>SMD Plastic-Encapsulate ESD Protection Diodes, SOD-523 series, 2 pads ESD5Z24 Type, TVs for ESD protection Reverse Working Voltage 24V, Clamping Voltage 35VC Max. Operating Temp. Range -55°C ~+150°C, Package in Tape/Reel, 3000pcs/Reel RoHS/RoHS III compliant</p>
CUSTOMER	
CUSTOMER PART NUMBER	
CROSS REF. PART NUMBER	
ORIGINAL PART NUMBER	MDD ESD5Z24
PART CODE	SOD5235Z24S05S

VENDOR APPROVE			
Issued/Checked/Approved			
DATE: Oct. 04, 2021			

CUSTOMER APPROVE	
DATE:	

SMD ESD PROTECTION DIODES SOD-523 SERIES

MAIN FEATURE

- IEC61000-4-2 (ESD) level 4 ESD Protection
- Protects one directional I/O line
- Low clamping voltage
- Low leakage current
- Working voltages : 24V
- Flammability Rating: UL 94V-0
- High temperature soldering recommended : 260°C/10s



APPLICATION

- Microprocessor based equipment
- Notebooks, Desktops, and Servers Cellular
- Personal digital assistants (PDA)
- Portable Instrumentation
- Peripherals

RFQ

[Request For Quotation](#)

PART CODE GUIDE

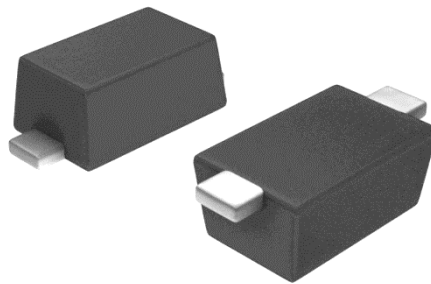
SOD523	5Z24	S	05S
1	2	3	4

- 1) **SOD523**: SMD Plastic-Encapsulate ESD Protection Diodes, SOD-523 series, 2 pads
- 2) **5Z24**: Type code for original part number ESD5Z24
- 3) **S**: Package code, Package in Tape/Reel, 3000pcs/Reel
- 4) **05S**: Marking code for "5S" on the case surface, Different Marking for different specification.

SMD ESD PROTECTION DIODES SOD-523 SERIES

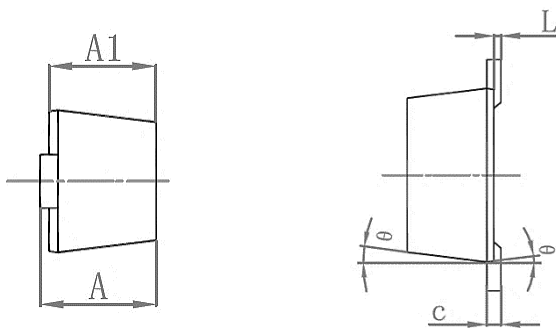
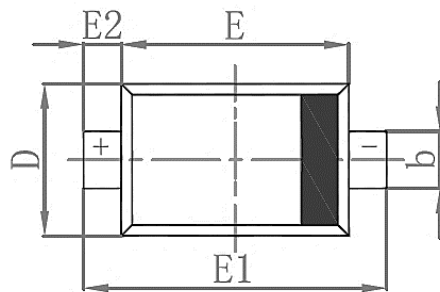
DIMENSION (Unit: Inch/mm)

Image for reference



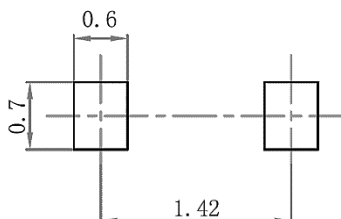
Marking: 5S

SOD-523

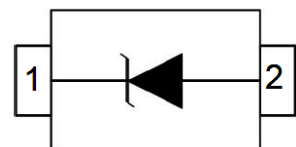


Symbol	Value (mm)		
	Min.	Typ.	Max.
A	0.51		0.770
A1	0.50		0.70
b	0.250		0.350
c	0.080		0.150
D	0.750		0.850
E	1.10		1.30
E1	1.50		1.70
E2	0.20 Ref.		
L	0.010		0.070
K	7° Ref.		

Recommend Pad Layout



Circuit Diagram



SMD ESD PROTECTION DIODES SOD-523 SERIES
MECHANICAL DATA

Case	Flammability Rating	Polarity	Mounting Position	Weight per piece
JEDEC SOD-523 molded plastic body	UL 94V-0	-	-	-

ABSOLUTE MAX. RATINGS AT Ta=25 °C (unless otherwise specified)

Parameter	SYMBOLS	VALUE	UNITS
		LIMIT	
ESD per IEC 61000-4-2 (Air)	V ESD	+/-15	KV
ESD per IEC 61000-4-2 (Contact)	V ESD	+/-8	KV
Total power dissipation on FR-5 Board (Note 1) @ Ta = 25°C	P D	150	mW
Operating Temperature Range	T J	-55 ~+ 150	°C
Storage Temperature Range	T STG	-55 ~ +150	°C
Lead Solder Temperature- Max. (10 s Duration)	T L	260 /10s	°C

Note: 1. FR-5=1.0x0.75x0.62 in.

ELECTRICAL CHARACTERISTICS (Ta=25 °C unless otherwise specified)

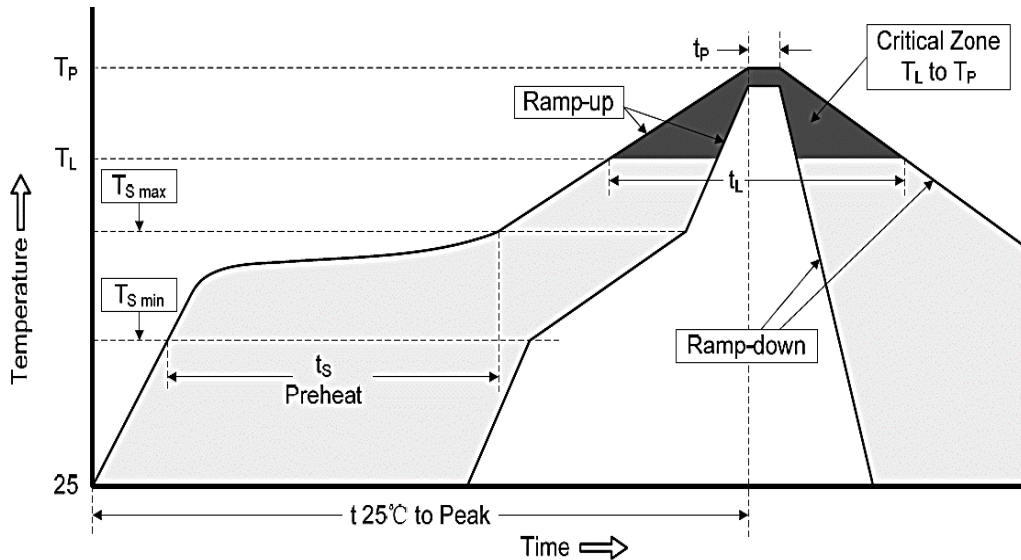
Parameter	SYMBOLS	VALUE			UNITS
		Min.	Typical	Max.	
Reverse Working Voltage	V RWM			24.0	V
Reverse Breakdown Voltage @ IT = 1.0mA	V BR	26			V
Reverse Leakage Current @V RWM = 24V	I R			5.0	µA
Clamping Voltage @ I PP = 1.0A, t p = 8/20µs	V C			35	V
Junction Capacitance	C J			50	pF

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RELIABILITY

Number	Experiment Items	Experiment Method And Conditions	Reference Documents
1	Solder Resistance Test	Test 260°C± 5°C for 10 ± 2 sec. Immerse body into solder 1/16" ± 1/32"	MIL-STD-750D METHOD-2031.2
2	Solderability Test	230°C ±5°C for 5 sec.	MIL-STD-750D METHOD-2026.1 0
3	Pull Test	1 kg in axial lead direction for 10 sec.	MIL-STD-750D METHOD-2036.4
4	Bend Test	0.5Kg Weight Applied To Each Lead, Bending Arcs 90 °C ± 5 °C For 3 Times	MIL-STD-750D METHOD-2036.4
5	High Temperature Reverse Bias Test	TA=100°C for 1000 Hours at VR=80% Rated VR	MIL-STD-750D METHOD-1038.4
6	Forward Operation Life Test	TA=25°C Rated Average Rectified Current	MIL-STD-750D METHOD-1027.3
7	Intermittent Operation Life Test	On state: 5 min with rated IRMS Power Off state: 5 min with Cool Forced Air. On and off for 1000 cycles.	MIL-STD-750D METHOD-1036.3
8	Pressure Cooker Test	15 PSIG, TA=121°C, 4 hours	MIL-S-19500 APPENOIXC
9	Temperature Cycling Test	-55°C~+125°C; 30 Minutes For Dwelled Time 5 minutes for transferred time. Total: 10 cycles.	MIL-STD-750D METHOD-1051.7
10	Thermal Shock Test	0°C for 5 minutes., 100°C for 5minutes, Total: 10 cycles	MIL-STD-750D METHOD-1056.7
11	Forward Surge Test	8.3ms Single Sale Sine-wave One Surge.	MIL-STD-750D METHOD-4066.4
12	Humidity Test	TA=65°C, RH=98% for 1000 hours.	MIL-STD-750D METHOD-1021.3
13	High Temperature Storage life Test	150°C for 1000 Hours	MIL-STD-750D METHOD-1031.5

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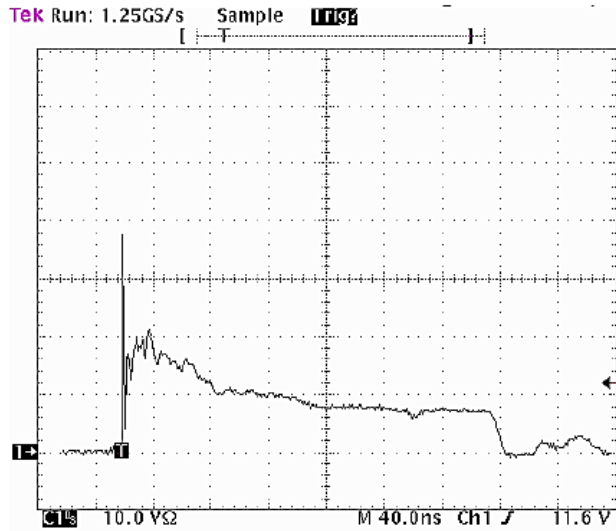
SUGGESTED REFLOW PROFILE (For Reference Only)



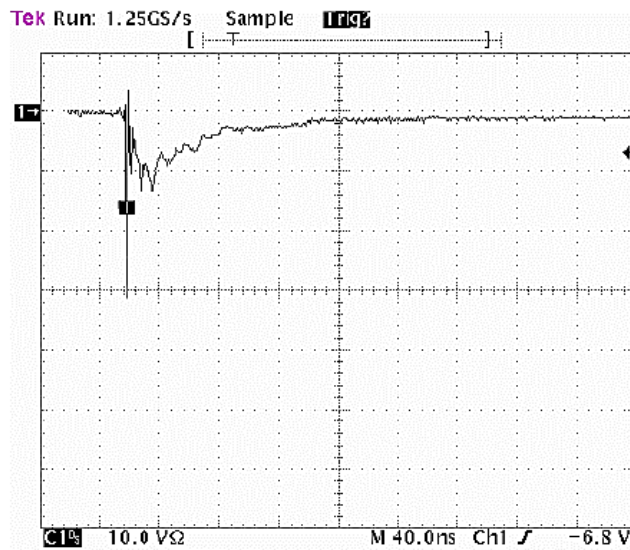
Profile Feature		Pb-Free Assembly
Average Ramp-up Rate (Ts Max to Tp)		3°C/second Max
Preheat	Temperature Min (Ts Min.)	150°C
	Temperature Max (Ts Max.)	200°C
	Time (ts Min. to ts Max.)	60 ~ 180 seconds
Time maintained above	Temperature (Tl)	217°C
	Time (ti)	60 ~ 150 seconds
Peak/Classification Temperature (Tp)		260 °C
Time within 5°C of actual Peak Temperature (tp)		20 ~ 40 seconds
Ramp-down rate		6 °C /Second Max.
Time 25 °C to Peak Temperature		8 minutes Max.
Suggest reflow times		3 Times Max.

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RATINGS AND CHARACTERISTIC CURVES (For Reference Only)



**Figure 1. ESD Clamping Voltage Screenshot
Positive 8 kV contact per IEC 61000-4-2**

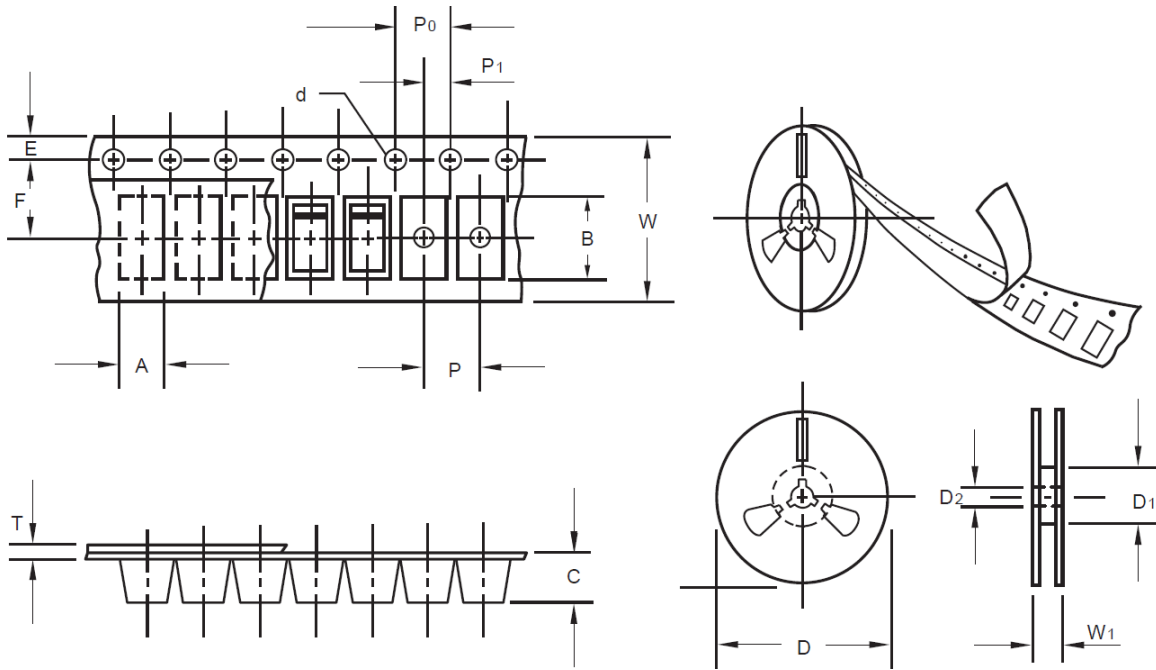


**Figure 2. ESD Clamping Voltage Screenshot
Negative 8 kV contact per IEC 61000-4-2**

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TAPE/REEL (Unit: mm)

All Devices are packed in accordance with EIA standard RS-481-A and specifications.



Item	Symbol	Tolerance	SOD-523
Carrier width	A	0.1	2.10
Carrier Length	B	0.1	4.00
Carrier Depth	C	0.1	1.60
Sprocket hole	d	0.05	1.55
7"Reel outside diameter	D	2.0	178.00
7"Reel inner diameter	D1	Min.	50.00
Feed hole diameter	D2	0.5	13.00
Sprocket hole position	E	0.1	1.75
Punch hole position	F	0.1	3.50
Punch hole pitch	P	0.1	4.00
Sprocket hole pitch	P0	0.1	4.00
Embossment center	P1	0.1	2.00
Overall tape thickness	T	0.1	0.25
Tape width	W	0.3	8.15
Reel width	W1	1.0	10.50

SMD ESD PROTECTION DIODES SOD-523 SERIES

SPQ PACKAGE for Reference

Item	Unit	Value
Case Code		SOD-523
Reel Size	Inch	7
Reel Size	mm	178
Tape Space	mm	/
SPQ /Reel	pcs	3000
Weigh /SPQ	LBS	
Weigh /SPQ	KGs	
Qty. Per Box	pcs	6,000
Inner Box	Inch	L8.0*W8.0*H1.5

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